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Kind regards,

Team Nexperia

NPN/NPN resistor-equipped transistors;

R1 = 47 kΩ, R2 = 47 kΩ

Rev. 5 — 5 December 2011

**Product data sheet** 

## 1. Product profile

### 1.1 General description

NPN/NPN double Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Type number	Package		NPN/PNP		Package
	NXP	JEITA	complement	complement	configuration
PEMH2	SOT666	-	PEMD12	PEMB2	ultra small and flat lead
PUMH2	SOT363	SC-88	PUMD12	PUMB2	very small

Reduces component count

AEC-Q101 qualified

Reduces pick and place costs

### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

### **1.3 Applications**

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

### 1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	100	mA
R1	bias resistor 1 (input)		33	47	61	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



23

sym063

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### NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$

## 2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	GND (emitter) TR1		
2	input (base) TR1	6 5 4	
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	output (collector) TR1	001aab555	

## 3. Ordering information

Table 4. Ord	Table 4.         Ordering information					
Type number	Package					
	Name	Description	Version			
PEMH2	-	plastic surface-mounted package; 6 leads	SOT666			
PUMH2	SC-88	plastic surface-mounted package; 6 leads	SOT363			

## 4. Marking

Table 5.    Marking codes	
Type number	Marking code <sup>[1]</sup>
PEMH2	Z2
PUMH2	2*H

[1] \* = placeholder for manufacturing site code

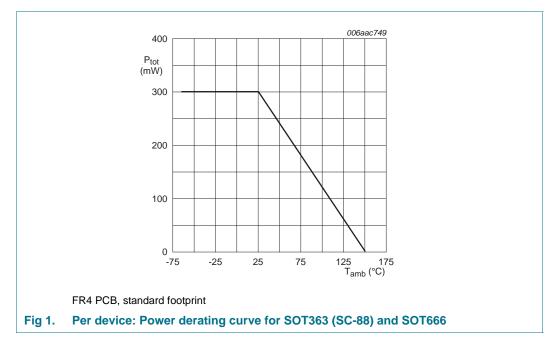
## 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	10	V
VI	input voltage				
	positive		-	+40	V
	negative		-	-10	V
I <sub>O</sub>	output current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PEMH2 (SOT666)		[1][2] _	200	mW
	PUMH2 (SOT363)		<u>[1]</u> -	200	mW
Per device	9				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PEMH2 (SOT666)		[1][2] _	300	mW
	PUMH2 (SOT363)		<u>[1]</u> -	300	mW
Т <sub>ј</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 



## 6. Thermal characteristics

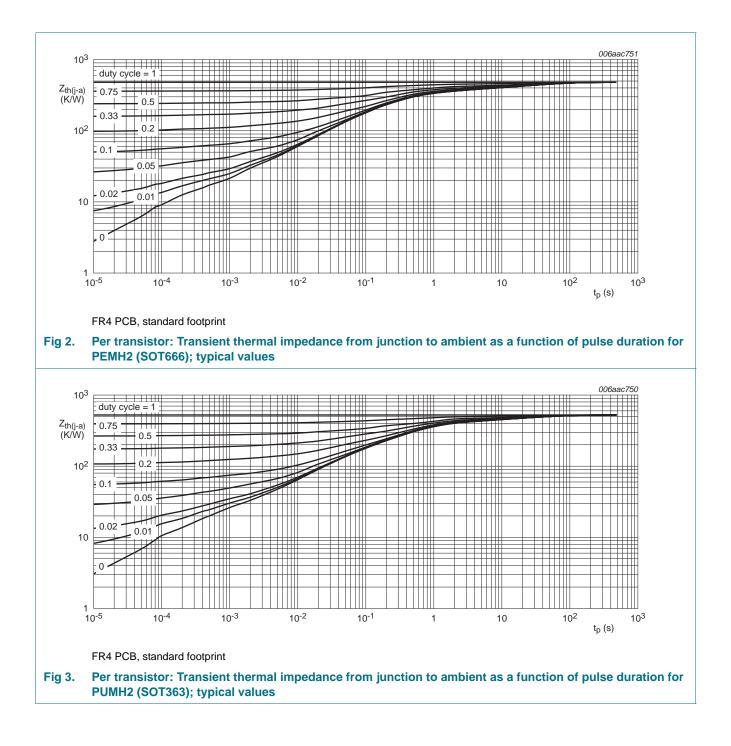
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transi	stor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PEMH2 (SOT666)		<u>[1][2]</u>	-	625	K/W
	PUMH2 (SOT363)		<u>[1]</u> _	-	625	K/W
Per device	9					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PEMH2 (SOT666)		[1][2] _	-	417	K/W
	PUMH2 (SOT363)		<u>[1]</u> _	-	417	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

## PEMH2; PUMH2

#### NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$



## 7. Characteristics

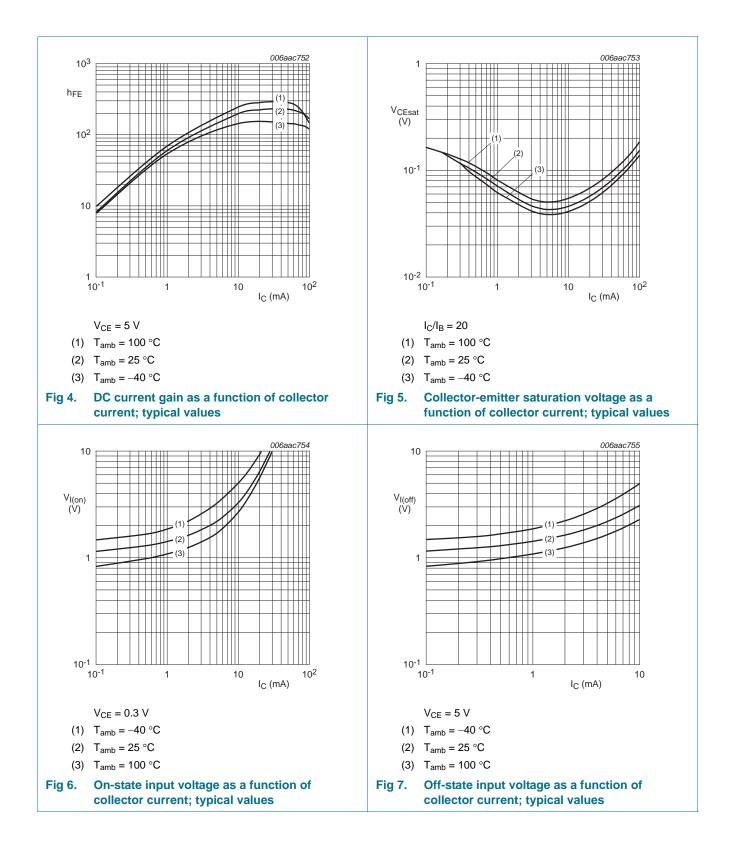
<b>Table 8.</b> $T_{amb} = 2\xi$	<b>Characteristics</b> 5 °C unless otherwise spe	ecified.					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per trans	sistor						
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
I <sub>CEO</sub>	collector-emitter cut-off	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$		-	-	1	μA
	current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	90	μΑ
h <sub>FE</sub>	DC current gain	$V_{CE}$ = 5 V; $I_{C}$ = 5 mA		80	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C}$ = 10 mA; $I_{\rm B}$ = 0.5 mA		-	-	150	mV
V <sub>I(off)</sub>	off-state input voltage	$V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A		-	1.2	0.8	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE}$ = 0.3 V; $I_{C}$ = 2 mA		3	1.6	-	V
R1	bias resistor 1 (input)			33	47	61	kΩ
R2/R1	bias resistor ratio			0.8	1	1.2	
C <sub>c</sub>	collector capacitance	$\label{eq:V_CB} \begin{array}{l} V_{CB} = 10 \; V; \\ I_E = i_e = 0 \; A; \; f = 1 \; MHz \end{array}$				2.5	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 10 \text{ mA};$ f = 100 MHz	<u>[1]</u>		230		MHz

[1] Characteristics of built-in transistor

PEMH2\_PUMH2 Product data sheet

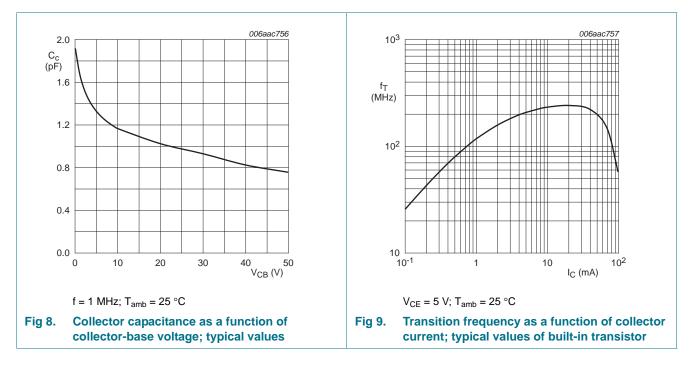
## PEMH2; PUMH2

#### NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$



## PEMH2; PUMH2

NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

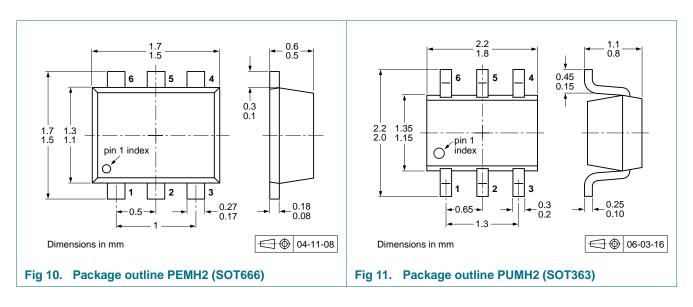


#### **Test information** 8.

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

#### **Package outline** 9.



PEMH2 PUMH2 **Product data sheet** 

## **10.** Packing information

#### Table 9. Packing methods

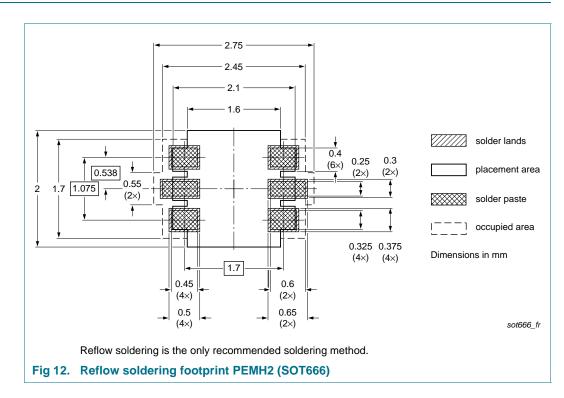
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Туре	Package	Description		Packin	g quant	ity	
number				3000	4000	8000	10000
PEMH2	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-315	-
		4 mm pitch, 8 mm tape and reel		-	-115	-	-
PUMH2	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165

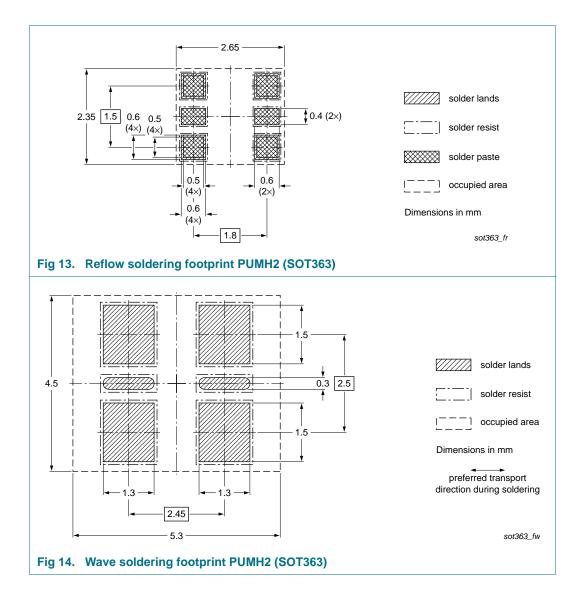
[1] For further information and the availability of packing methods, see Section 14.

- [2] T1: normal taping
- [3] T2: reverse taping

## 11. Soldering



#### NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$



PEMH2\_PUMH2
Product data sheet

10 of 14

## 12. Revision history

ory			
Release date	Data sheet status	Change notice	Supersedes
20111205	Product data sheet	-	PEMH2_PUMH2 v.4
• Table 1 "Proc	duct overview": corrected		
20111116	Product data sheet	-	PEMH2_PUMH2 v.3
20040414	Product data sheet	-	PEMH2_PUMH2 v.2
20031002	Product specification	-	PEMH2 v.1 PUMH2 v.1
20011022	Preliminary specification	-	-
19990803	Product specification	-	-
	Table 1 "Prod           20111205           • Table 1 "Prod           20111116           20040414           20031002           20011022	Release dateData sheet status20111205Product data sheet• Table 1 "Product overview": corrected20111116Product data sheet20040414Product data sheet20031002Product specification20011022Preliminary specification	Release dateData sheet statusChange notice20111205Product data sheet-• Table 1 "Product overview": corrected-20111116Product data sheet-20040414Product data sheet-20031002Product specification-20011022Preliminary specification-

## 13. Legal information

#### **13.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PEMH2 PUMH2

#### NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$

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## PEMH2; PUMH2

NPN/NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$ 

## **15. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 4
7	Characteristics 6
8	Test information 8
8.1	Quality information 8
9	Package outline 8
10	Packing information 9
11	Soldering 9
12	Revision history 11
13	Legal information 12
13.1	Data sheet status 12
13.2	Definitions 12
13.3	Disclaimers 12
13.4	Trademarks 13
14	Contact information 13
15	Contents 14

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Date of release: 5 December 2011 Document identifier: PEMH2\_PUMH2

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